

Description

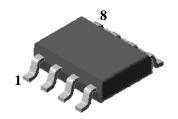
The S8300 is an integrated adjustable constant-current source, driving loads up to 600mA. The output current level can be adjusted via an external resistor(R_{FB}). The integrated SHDN input of the S8300P permits LED brightness regulation by pulse width modulation (PWM), with the SHDN input, the LED brightness can be regulated via duty cycle. Also, SHDN low sets the S8300 in sleep mode, the SHDN pin also can be used as an enable input.

This discrete integration technology eliminates individual components by combining them into a single package, which results in a significant reduction of both system cost and board space.

• Features

- Supplies stable bias current for LEDs
- LED drive current adjustable via single external resistor (Max 600mA)
- Low Cost, Low External Parts Count
- Halogen-Free Package is Available

♦ Pin Assignment & Description



Package: SOP-8

| Pin No | Symbol | Description |
|--------|--------|---------------------------|
| 1 | VCC | Power Supply |
| 2 | SHDN | Disable On/Off |
| 3 | GND | Ground |
| 4 | N.C | No connection |
| 5 | N.C | No connection |
| 6 | N.C | No connection |
| 7 | OUTPUT | Open Collector Output |
| 8 | FB | Feedback / 0.2V Reference |

Ordering Information

| Package Type | Device Name | Marking |
|--------------|-------------|---------|
| SOP-8 | S8300 | S8300 |

KSD-I7F016-001

Absolute maximum ratings

[Ta=25℃]

| Characteristic | Symbol | Rating | Unit |
|-------------------------------------|-----------------------|------------|----------------------|
| Power Supply Voltage | $V_{CC(MAX)}$ | 25 | V |
| Output Voltage | $V_{OUT(MAX)}$ | 25 | V |
| Output Sink Current | I _{OUT(MAX)} | 600 | mA |
| Thermal Resistance Junction-Ambient | Rth(j-a)* | 156.3 | °C/W |
| Power Dissipation | P _D * | 0.8 | W |
| Operating Temperature Range | T _{opr} | -40 ~ +85 | $^{\circ}\mathbb{C}$ |
| Storage Temperature Range | T _{stg} | -55 ~ +125 | $^{\circ}$ |

^{*:} Mounted on a glass epoxy circuit board of 50x50mm Pad dimension of 50mm²

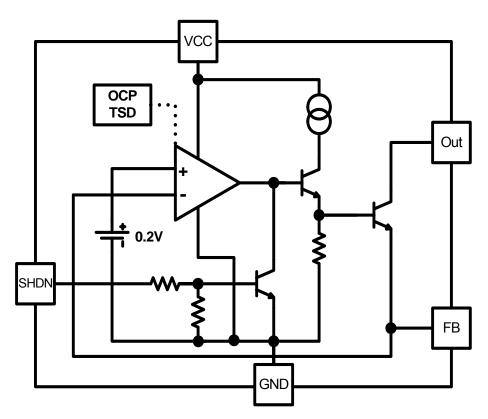
Recommended operating conditions

| Characteristic | Symbol | Rating | | Unit |
|----------------------|------------------|--------|-----|------|
| Characteristic | | Min | Max | |
| Power Supply Voltage | V _{CC} | 3 | 24 | V |
| Output Voltage | V _{OUT} | 1.5 | Vcc | V |
| Output Sink Current | I _{OUT} | - | 500 | mA |
| Shut Down Voltage | SHDN | -0.3 | Vcc | V |

igoplus Electrical Characteristics (Ta=25 $^{\circ}$ C, unless otherwise noted.)

| Characteristic | Symbol | Condition | Min. | Typ. | Max. | Unit |
|-----------------------|---------------------|--|------|------|------|------|
| IQ Maximum | ΙQ | V _{CC} =3~24V, lout=20mA, Vout=open | - | 8 | 12 | mA |
| Leak Current | lleak | Vcc=5V, Vout=24V | 1 | 0.1 | 1 | μΑ |
| Feedback Voltage | V_{FB} | V _{CC} =5V, lout=10mA | ı | 200 | 208 | mV |
| Dropout Voltage | Vdrop | V _{CC} =5V, lout=500mA | - | 0.5 | 1.5 | V |
| Line Regulation | $\triangle V_{FB1}$ | V _{CC} =3V~24V, lout=10mA | - | 2 | 10 | mV |
| Load Regulation | $\triangle V_{FB2}$ | V _{CC} =5V, lout=10mA~lomax | 1 | 3 | 25 | mV |
| SHDN Voltage On | Vdis on | V _{CC} =5V, lout=10mA, Vout=Vcc | 1.5 | - | ı | V |
| SHDN Voltage Off | Vdis off | V _{CC} =5V, lout=10mA | - | - | 0.5 | V |
| SHDN Pin Current | Idis | Vcc=5V, SHDN=5V | 230 | 430 | 630 | μΑ |
| Short Circuit Current | I _{SC} | R _{FB} =0Ω | | 1300 | ı | mA |
| Thermal Shutdown | T_{TSD} | - | - | 160 | - | Ç |

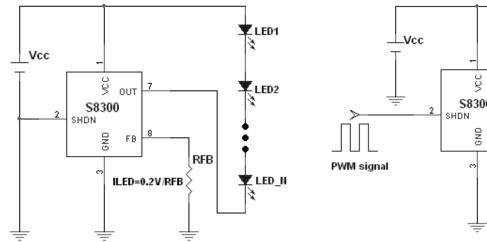
♦ Functional block diagram



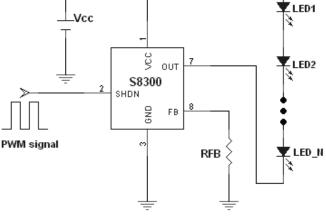
Design Consideration

- 1) Calculation for $R_{\text{FB}}\,$
 - $R_{FB} = 0.2 V \ / \ I_{LED}$
- 2) Calculation for Vdrop
 - $Vdrop = V_{CC} V_{LED}$
- 3) Calculation for Power Dissipation on the S8300P
 - $\text{-}P_{D1} = (Vdrop V_{FB}) \text{ x } I_{LED}$
 - $P_{\rm D2}$ = $V_{\rm CC}$ x I_Q
 - $-P_{D(total)} = P_{D1} + P_{D2}$
- 4) If does not use an Dimming function, connect SHDN Pin with the ground.
- 5) When $V_{\rm cc}$ uses to exceed 25V, Dimming functions the use is impossible.

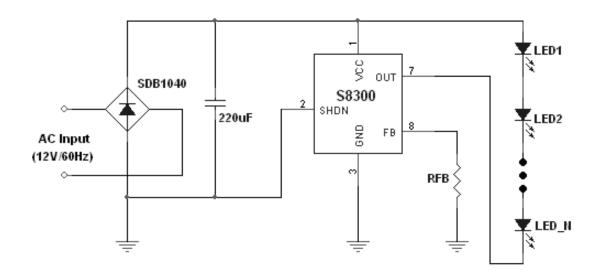
♦ Typical Applications



<APP1. Constant Current LED Driver Circuit>

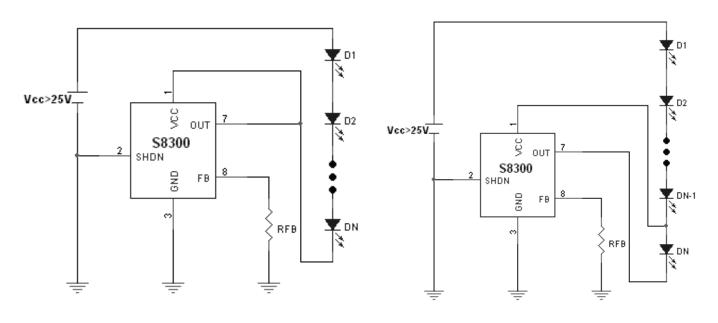


<APP2. PWM Dimming LED Driver Circuit>



<APP3. V_{AC} Landscape Lighting Application Circuit>

Typical Applications



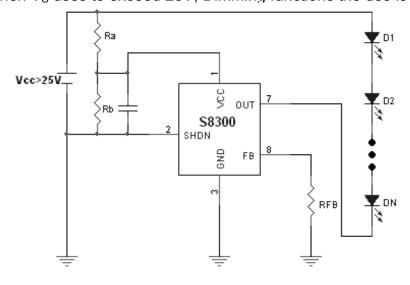
<APP4. High Voltage Operation of S8300P(1) >

<APP5. High Voltage Operation of S8300P (2) >

For operation in excess of S8300 specified maximum voltage (V_{CC} & V_{OUT}) of 25V, one way is to connect a sufficient number of LEDs between the power supply voltage and the DC input of the V_{CC} & V_{OUT} such that the voltage seen at pin(V_{CC} & V_{OUT}) is less than 25V.

That is to say, use additional LEDs to drop the voltage fed to the S8300 below its maximum rating, in the usual way. Refer to **APP4,5** Note that the exact number of diodes required will depend on the supply voltage V_{CC} and output voltage V_{OUT} , the voltage drops across the particular LEDs being used. (Red, Blue and White LEDs have different forward voltage drop.) Use enough LEDs such that voltage at pin(V_{CC} & V_{OUT}) of S8300 is < 25V

Caution: When V_S uses to exceed 25V, Dimming functions the use is impossible.

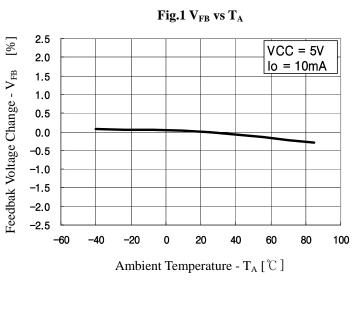


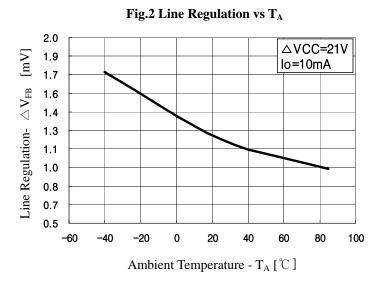
<APP6. Power Supply Where Separates Operation of S8300P >

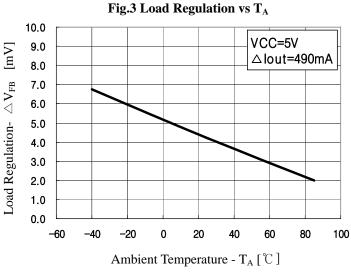
KSD-I7F016-001

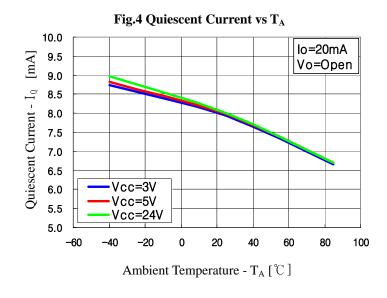
5

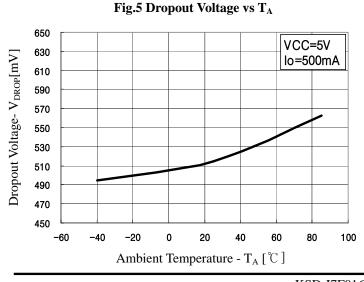
Electrical Characteristic Curves

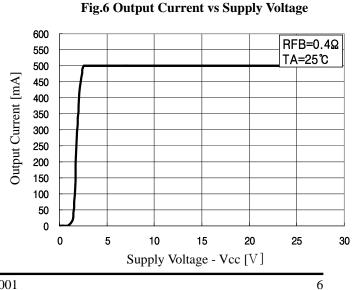






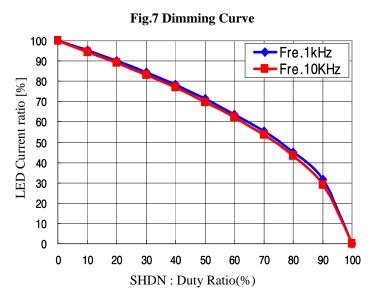


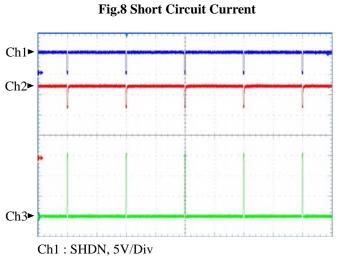




KSD-I7F016-001

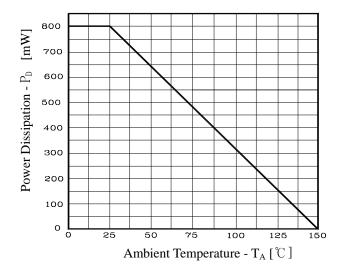
♦ Electrical Characteristic Curves



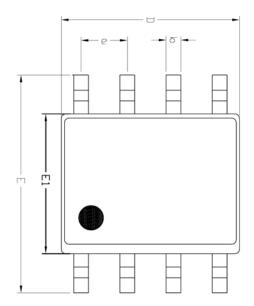


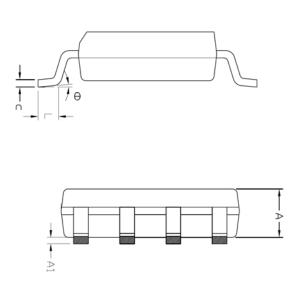
$$\label{eq:ch2:Vout} \begin{split} &\text{Ch2:V}_{\text{OUT}},\,5\text{V/Div} \\ &\text{Ch3:I}_{\text{OUT}},\,500\text{mA/Div} \end{split}$$

Fig.9 Power Dissipation vs T_A



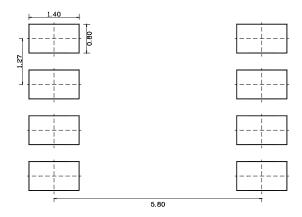
SOP-8 Outline Dimension (mm)





| SYMBOL | MILLIMETER(mm) | | | NOTE |
|--------|----------------|---------|---------|-------|
| | MINIMUM | NDMINAL | MAXIMUM | 14012 |
| Α | 1.245 | _ | 1.445 | |
| A1 | 0.125 | 0.175 | 0.275 | |
| b | 0.320 | 0.420 | 0.520 | |
| С | 0.170 | 0.220 | 0.270 | |
| D | 4.802 | 4.902 | 5.002 | |
| Ε | 5.870 | 6.020 | 6.170 | |
| E1 | 3.761 | 3.861 | 3.961 | |
| е | 1.270 BSC | | | |
| L | 0.462 | 0.562 | 0.662 | |
| θ | 0 * | _ | 8 * | |

* Recommend PCB solder land [Unit: mm]



The AUK Corp. products are intended for the use as components in general electronic equipment (Office and communication equipment, measuring equipment, home appliance, etc.).

Please make sure that you consult with us before you use these AUK Corp. products in equipments which require high quality and / or reliability, and in equipments which could have major impact to the welfare of human life(atomic energy control, airplane, spaceship, transportation, combustion control, all types of safety device, etc.). AUK Corp. cannot accept liability to any damage which may occur in case these AUK Corp. products were used in the mentioned equipments without prior consultation with AUK Corp..

Specifications mentioned in this publication are subject to change without notice.